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EXPEDITED PROCEDURE

Group Art Unit: 2822

Docket No.: TESSERA 3.0-139 DIV

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:	:
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Thomas H. DiStefano	:
	:
Application No.: 09/854,269	: Group Art Unit: 2822
	:
Filed: May 11, 2001	: Examiner: M. Lewis
	:
For: MICROELECTRONIC PACKAGES WITH	:
SOLDER INTERCONNECTIONS	:

AMENDMENT UNDER 37 C.F.R. § 1.116

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Official Action dated December 2, 2004, finally rejecting claims 1-3, please amend the above-identified U.S. patent application as follows: